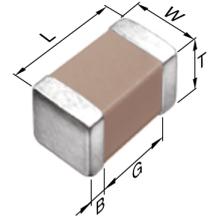


CGJ5H4X7R2H332K115AA



TDK item description CGJ5H4X7R2H332KT****

Applications	High Reliability Grade
Feature	Mid Voltage (100 to 630V) AEC-Q200
Series	CGJ5(3216) [EIA 1206]
Status	Production (Not Recommended for New Design)



Dimensions in mm

Size	
Length(L)	3.20mm ±0.20mm
Width(W)	1.60mm ±0.20mm
Thickness(T)	1.15mm ±0.15mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern (PA)	2.10mm to 2.50mm(Flow Soldering)
	2.00mm to 2.40mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.10mm to 1.30mm(Flow Soldering)
	1.00mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PC)	1.00mm to 1.30mm(Flow Soldering)
	1.10mm to 1.60mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	3.3nF ±10%
Rated Voltage	500VDC
Temperature Characteristic	X7R(±15%)
Dissipation Factor (Max.)	3%
Insulation Resistance (Min.)	10000MΩ

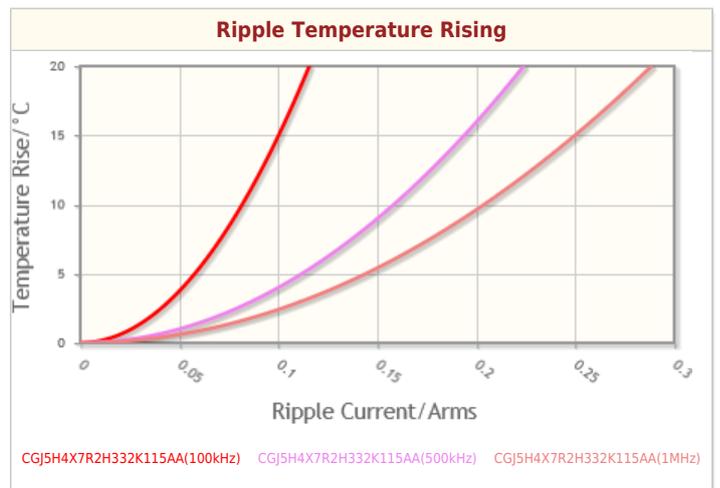
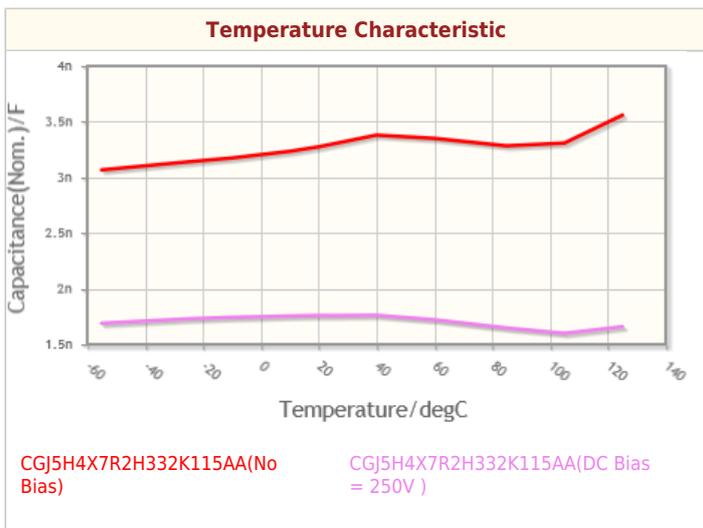
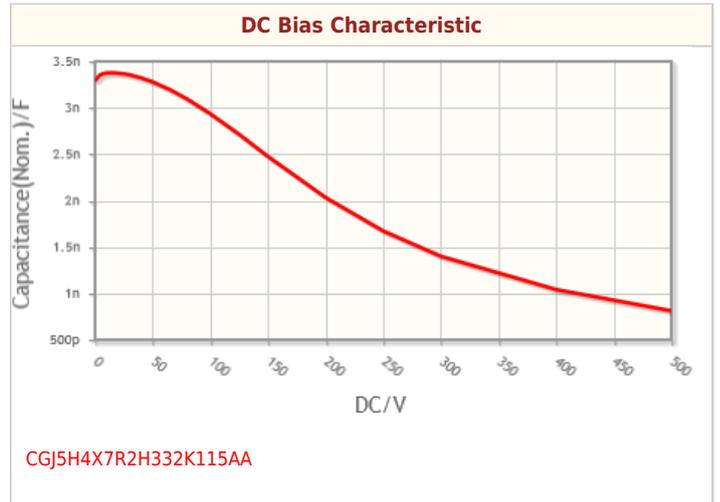
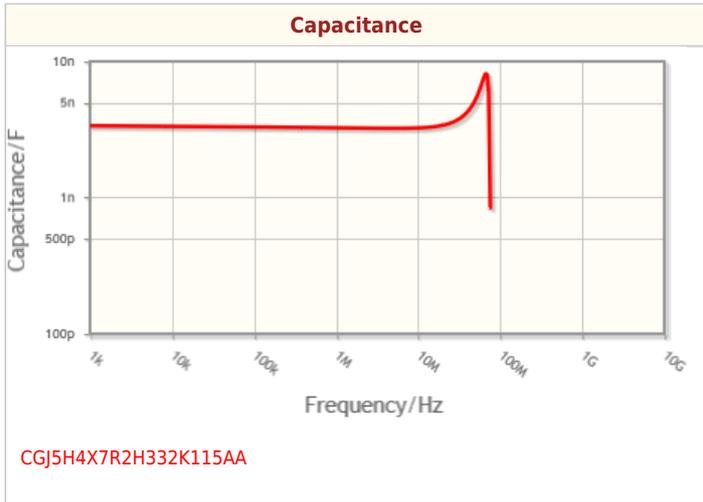
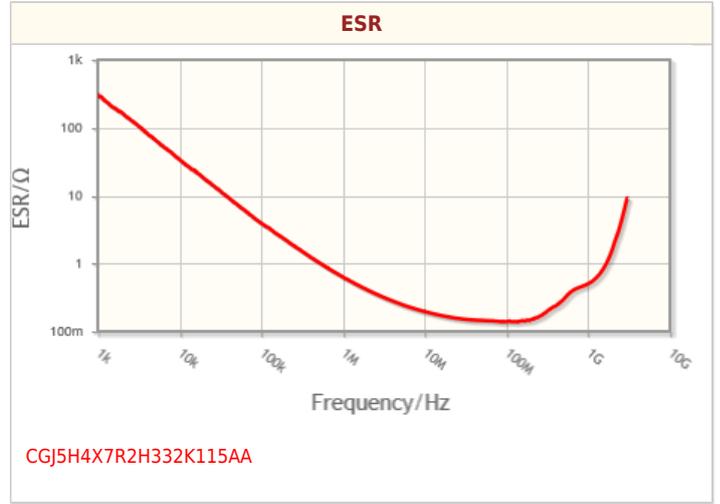
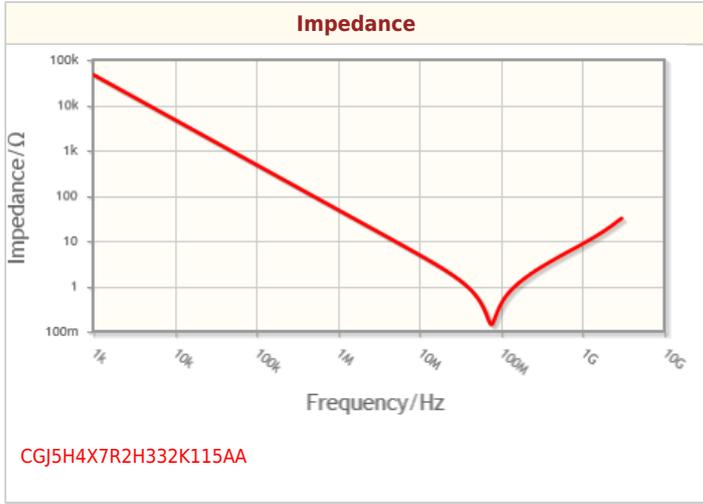
Other	
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

CGJ5H4X7R2H332K115AA



Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



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Associated Images

